

Rev. 1.8

Dual 2.0W/CH Stereo Audio Amplifier include Headphone Function

FEATURES

- 2.5V~5.5V Power supply.
- Thermal shutdown Protection.
- Low current shutdown mode.
- No capacitors and networks or bootstrap capacitors required.
- Low noise during turn-on and turn-off transitions.
- User selectable stereo headphone function.
- User selectable shutdown high or low logic level. (SOP package only)
- Lead free and green package available. (RoHS Compliant)
- Space Saving Package
 - -- 16-pin QFN 3*3 Package.
 - -- 16-pin QFN 4*4 Package.
 - -- 16-pin SOP Package.

APPLICATION

- Portable electronic devices
- Portable and desktop computers
- Cell Phones
- Multimedia Monitors
- Audio System

GENERAL DESCRIPTION

The LY8661 is a dual bridge-connected audio power amplifier. It is capable of driving $4\,\Omega\,$ speaker load at a continuous average output of 2.0W / 10% distortion (THD+N) from a 5.5V power supply. It primarily designed for high quality application in other portable communication device and portable and desktop computers device.

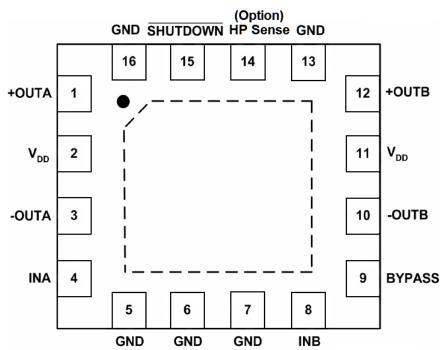
The audio amplifier features low power consumption in shutdown mode. Shutdown may be enabled by either logic high or low depending on mode selection(SOP package only). And it has an internal thermal shutdown protection feature.

LY8661 audio amplifier was designed specifically to provide high quality output power with a minimal amount of external components. The LY8661 does not require output capacitors, and it is ideally suited for other low voltage applications or portable electronic devices where minimal power consumption is a primary requirement.

PIN CONFIGURATION

16 Pin QFN Package (Top View)

www.DataSheet4U.com



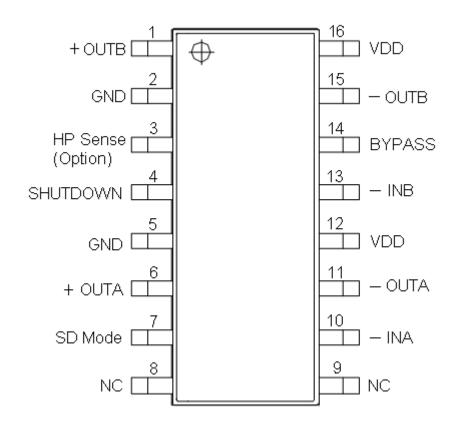
Lyontek Inc. reserves the rights to change the specifications and products without notice.

5F, No. 2, Industry E . Rd. IX, Science-Based Industrial Park, Hsinchu 300, Taiwan

Rev. 1.8

Dual 2.0W/CH Stereo Audio Amplifier include Headphone Function

16 Pin SOP Package (Top View)



www.D.PIN DESCRIPTION

SYMBOL	Pin No.		DESCRIPTION	
STWBOL	QFN	SOP	DESCRIPTION	
+OUTA	1	6	Positive BTL output of A channel.	
Vdd	2/11	12/16	Power supply.	
-OUTA	3	11	Negative BTL output of A channel.	
INA	4	10	Input of A channel.	
GND	5/6/7/13/16	2/5	Ground.	
INB	8	13	Input of B channel.	
BYPASS	9	14	Bypass capacitor which provides the common mode voltage.	
-OUTB	10	15	Negative BTL output of B channel.	
+OUTB	12	1	Positive BTL output of B channel.	
HP Sense (Option)	14	3	Headphone sense pin option. (If None headphone function must connect to GND).	
SHUTDOWN	15	4	Shutdown the device pin.	
SD Mode		7	Shutdown Mode Selectable.	
NC		8/9	No connection.	

Lyontek Inc. reserves the rights to change the specifications and products without notice.

5F, No. 2, Industry E . Rd. IX, Science-Based Industrial Park, Hsinchu 300, Taiwan

Rev. 1.8

Dual 2.0W/CH Stereo Audio Amplifier include Headphone Function

APPLICATION CIRCUIT

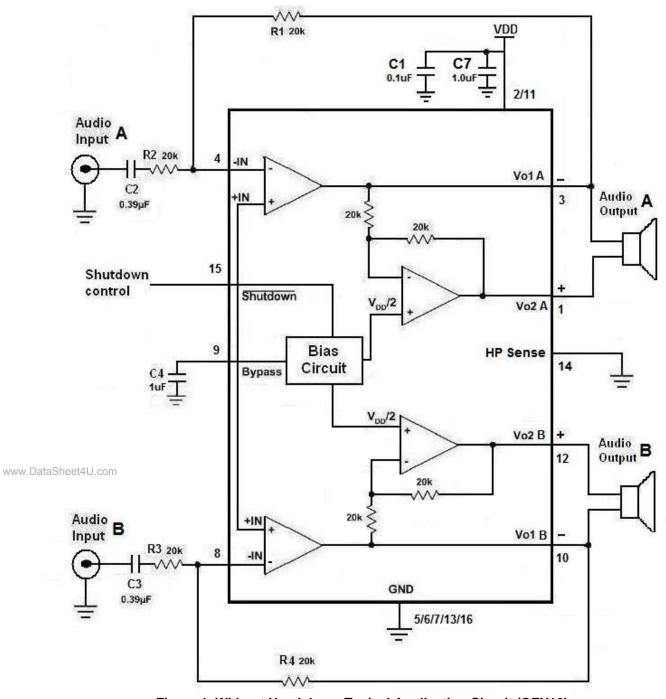


Figure 1. Without Headphone Typical Application Circuit (QFN16)

Rev. 1.8

Dual 2.0W/CH Stereo Audio Amplifier include Headphone Function

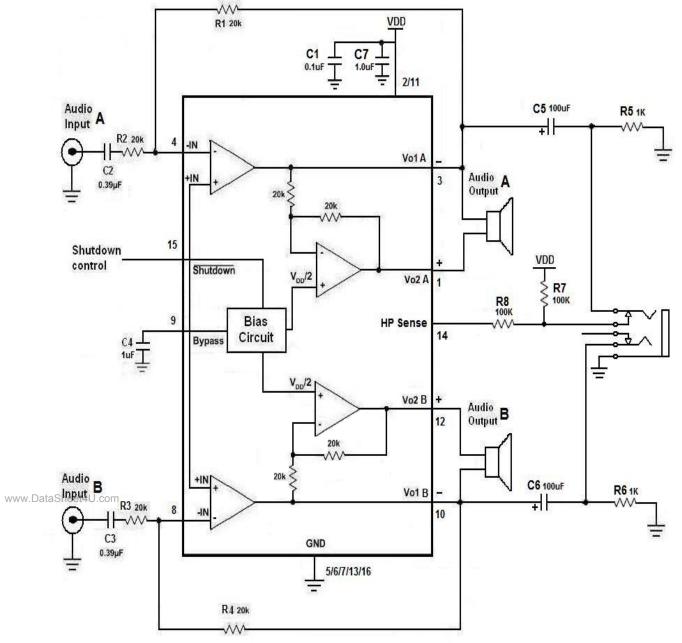


Figure 2. With Headphone Typical Application Circuit (QFN16)

Rev. 1.8

Dual 2.0W/CH Stereo Audio Amplifier include Headphone Function

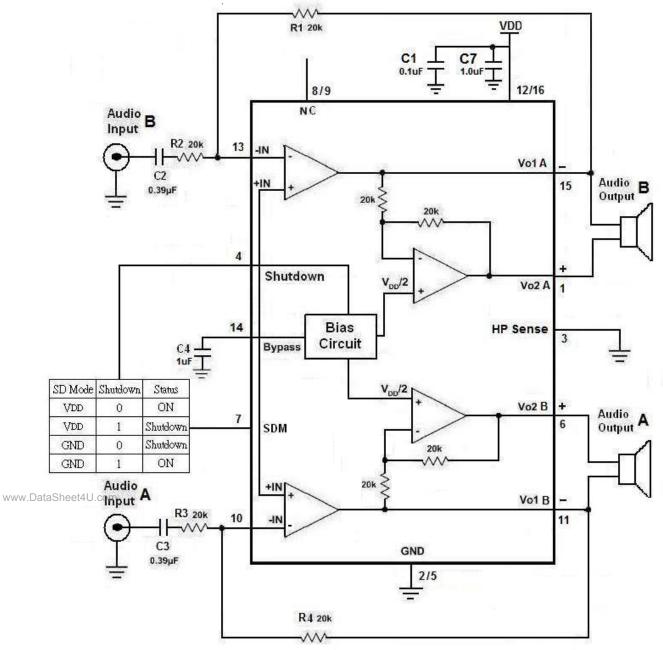


Figure 3. Without Headphone Typical Application Circuit (SOP16)

Rev. 1.8

Dual 2.0W/CH Stereo Audio Amplifier include Headphone Function

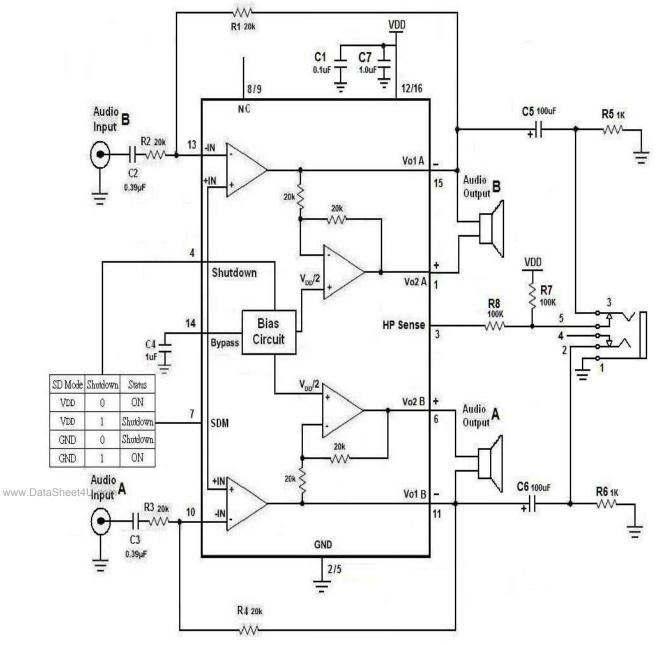


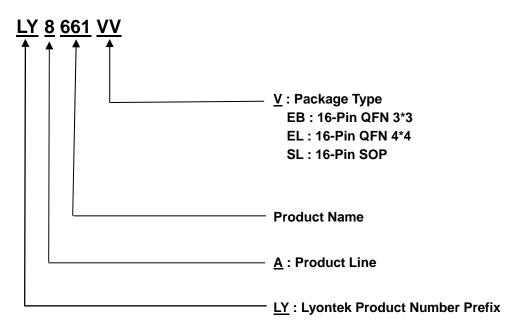
Figure 4. With Headphone Typical Application Circuit (SOP16)



Rev. 1.8

Dual 2.0W/CH Stereo Audio Amplifier include Headphone Function

ORDERING INFORMATION



ABSOLUTE MAXIMUN RATINGS*

www.DataSheet4U.com

PARAMETER	SYMBOL	RATING	UNIT
Supply Voltage	V _{DD}	6.0	V
Operating Temperature	TA	-40 to 85 (I grade)	$^{\circ}\! \mathbb{C}$
Input Voltage	Vı	-0.3V to V _{DD} +0.3V	V
Storage Temperature	Тѕтс	-65 to 150	$^{\circ}\! \mathbb{C}$
Power Dissipation	PD	Internally Limited	W
ESD Susceptibility	Vesd	2000	V
Junction Temperature	Тлмах	150	$^{\circ}\! \mathbb{C}$
Soldering Information	Vapor Phase (60 sec.)	215	$^{\circ}\! \mathbb{C}$
Soldering information	Infrared (15 sec.)	220	C

Rev. 1.8

Dual 2.0W/CH Stereo Audio Amplifier include Headphone Function

DC ELECTRICAL CHARACTERISTICS (VDD=5.0V, TA=25°C)

PARAMETER	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Power Supply Current	I _{DD}	V_{DD} =5.0V, 8Ω Load (BTL)	-	12.0	21.5	mA
Shutdown Current	I _{SD}	V _{SHUTDOWN} = 0V, HP sense= GND	-	0.1	1.0	μA
Shutdown, Headphone Sense High Input Voltage	Vsdih		1.4	-	-	V
Shutdown, Headphone Sense Low Input Voltage	VsDIL		-	-	0.4	V
Wake-up time	Twu	Bypass cap.=1.0uF	-	172	-	ms
Output Offset Voltage	Vos		-	7.0	50.0	mV
		THD+N = 1%, f = 1 kHz, RL=8 Ω	-	1.1	-	- W - mW
		THD+N = 10%, f = 1 kHz RL=8Ω	-	1.4	-	
	Po	THD+N = 1%, f = 1 kHz RL=4 Ω	-	1.4	-	
Output Power		THD+N = 10%, f = 1 kHz RL=4Ω	-	1.8	-	
		THD+N = 10%, f = 1 kHz RL=4Ω (at 5.5V)	-	2.0	-	
		THD+N = 0.1%, f = 1 kHz, RL=32 Ω (SE Mode)	-	90	-	
		THD+N = 0.1%, f = 1 kHz, RL=16 Ω (SE Mode)	-	165	-	
Total Harmonic Distortion+ Noise	THD+N	Po = 0.4 Wrms; f = 1kHz, RL=8 Ω	-	0.11	-	%
Rower Supply Rejection Ratio	PSRR	Vripple = 200mV sine p-p Input terminated with 10Ω to GND	-	62 (f = 217Hz) 66 (f = 1kHz)	-	dB
Output valtaga naiga	Vn	f = 20 Hz to 20 kHz, A-weighting	-	37.5	-	uV
Output voltage noise		f = 20 Hz to 20 kHz, A-weighting (SE mode)	-	15	-	uv
Thermal Shutdown Temperature	T _{SD}		150	170	190	$^{\circ}\!\mathbb{C}$
Shutdown Time	TSDT	8 Ω load	_	1.0	_	ms

Lyontek Inc. reserves the rights to change the specifications and products without notice.

5F, No. 2, Industry E . Rd. IX, Science-Based Industrial Park, Hsinchu 300, Taiwan



Rev. 1.8

Dual 2.0W/CH Stereo Audio Amplifier include Headphone Function

DC ELECTRICAL CHARACTERISTICS (VDD=3.6V, TA=25°C)

PARAMETER	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Power Supply Current	IDD	V_{DD} =3.6V, 8 Ω Load (BTL)	-	10.0	16.5	mA
Shutdown Current	I _{SD}	V _{SHUTDOWN} = 0V HP sense= GND	-	0.1	2.0	μA
Shutdown, Headphone Sense High Input Voltage	VsDIH		1.4	-	-	٧
Shutdown, Headphone Sense Low Input Voltage	VsDIL		-	-	0.4	٧
Wake-up time	Twu	Bypass cap.=1.0uF	-	82	-	ms
Output Offset Voltage	Vos		ı	7.0	50	mV
		THD+N = 1%, f = 1 kHz, RL=8 Ω	-	0.5	-	
	Po	THD+N = 10%, f = 1 kHz RL=8 Ω	-	0.65	-	- W - mW
Outrant Dames		THD+N = 1%, f = 1 kHz RL=4 Ω	-	0.65	-	
Output Power		THD+N = 10%, f = 1 kHz RL=4Ω	-	0.8	-	
		THD+N = 0.1%, f = 1 kHz, RL=32 Ω (SE Mode)	-	45	-	
		THD+N = 0.1%, f = 1 kHz, RL=16 Ω (SE Mode)	-	83	-	
Total Harmonic Distortion+ Noise	THD+N	Po = 0.2 Wrms; f = 1kHz, RL=8 Ω	-	0.12	-	%
Power Supply Rejection Ratio	PSRR	Vripple = 200mV sine p-p Input terminated with 10Ω to GND	ı	56 (f = 217Hz) 62 (f = 1kHz)	-	dB
ntaSheet#U.com Output voltage noise	Vn	f = 20 Hz to 20 kHz, A-weighting	-	37.5	-	uV
. •		f = 20 Hz to 20 kHz, A-weighting (SE mode)	-	15	-	uv
Thermal Shutdown Temperature	T _{SD}		150	170	190	$^{\circ}\!\mathbb{C}$
Shut Down Time	TSDT	8 Ω load	-	1.0	-	ms

Lyontek Inc. reserves the rights to change the specifications and products without notice.

5F, No. 2, Industry E . Rd. IX, Science-Based Industrial Park, Hsinchu 300, Taiwan



Rev. 1.8

Dual 2.0W/CH Stereo Audio Amplifier include Headphone Function

APPLICATION INFORMATION

The LY8661's QFN package provides a low thermal resistance between the die and the PCB to which the part is mounted and soldered. This allows rapid heat transfer from the die to the surrounding PCB copper traces, ground plane and, finally, surrounding air. The result is a low voltage audio power amplifier that produces 2.0W at 10% THD with a 4Ω load. This high power is achieved through careful consideration of necessary thermal design. Failing to optimize thermal design may compromise the LY8661's high power performance and activate unwanted, though necessary, thermal shutdown protection.

POWER SUPPLY BYPASSING

As with any power amplifier, proper supply bypassing is critical for low noise performance and high power supply rejection. Applications that employ a 5V regulator typically use a 10 μ F in parallel with a 0.1 μ F filter capacitor to stabilize the regulator's output, reduce noise on the supply line, and improve the supply's transient response. However, their presence does not eliminate the need for a local 1.0 μ F tantalum bypass capacitance connected between the LY8661's supply pins and ground. Do not substitute a ceramic capacitor for the tantalum. Doing so may cause oscillation. Keep the length of leads and traces that connect capacitors between the LY8661's power supply pin and ground as short as possible.

MICRO-POWER SHUTDOWN

The voltage applied to the SHUTDOWN pin controls the LY8661's shutdown function. Activate micro-power shutdown by applying GND to the SHUTDOWN pin. When active, the LY8661's micro-power shutdown feature turns off the amplifier's bias circuitry, reducing the supply current. The low 0.1 µA typical shutdown current is achieved by applying a voltage that is as near as GND as possible to the SHUTDOWN pin. A voltage that is more than GND may increase the shutdown current.

Table 1 shows the logic signal levels that activate and deactivate micro-power shutdown and headphone amplifier operation.

There are a few ways to control the micro-power shutdown. These include using a single-pole, single-throw switch, a microprocessor, or a microcontroller. When using a switch, connect an external 20k resistor between the SHUTDOWN pin and Ground. Connect the switch between the SHUTDOWN pin VDD. Select normal amplifier operation by closing the switch. Opening the switch sets the SHUTDOWN pin to ground through the 20k resistor, which activates the micro-power shutdown. The switch and resistor guarantee that the SHUTDOWN pin will not float. This prevents unwanted state changes. In a system with a microprocessor www.Doramicrocontroller, use a digital output to apply the control voltage to the SHUTDOWN pin. Driving the SHUTDOWN pin with active circuitry eliminates the pull up resistor.

TABLE 1. Logic Level Truth Table

Shutdown Pin	Headphone Jack	Operational Output			
Shutdown Fill	Sense Pin	Mode			
Logic High	Low (HP not Plugged in)	BTL			
Logic High	High (HP Plugged in)	Single-Ended			
Logic Low	High or Low Don't care	Micro-Power Shutdown			

HEADPHONE SENSE AND HEADPHONE LOGIC IN FUNCTIONS

Applying a logic level to the LY8661's HP Sense headphone control pin turns off Amp. A (+out) and Amp. B (+out) muting a bridged-connected load. Quiescent current consumption is reduced when the IC is in this single-ended mode.

Figure 2 shows the implementation of the LY8661's headphone control function. With no headphones connected to the headphone jack, the R5-R6 voltage divider sets the voltage applied to the HP Sense pin (pin 14) at approximately 50mV. This 50mV enables Amp A (+out) and Amp B (+out) placing the LY8661 in bridged mode operation.

While the LY8661 operates in bridged mode, the DC potential across the load is essentially 0V. Therefore, even in an ideal situation, the output swing cannot cause a false single-ended trigger. Connecting headphones to the headphone jack disconnects the headphone jack contact pin from -OUTA and allows R7 to pull the HP Sense pin up to VDD.

Lyontek Inc. reserves the rights to change the specifications and products without notice.

5F, No. 2, Industry E . Rd. IX, Science-Based Industrial Park, Hsinchu 300, Taiwan



Rev. 1.8

Dual 2.0W/CH Stereo Audio Amplifier include Headphone Function

This enables the headphone function, turns off Amp A (+out) and Amp B (+out) which mutes the bridged speaker. The amplifier then drives the headphones, whose impedance is in parallel with resistors R5 and R6. These resistors have negligible effect on the LY8661's output drive capability since the typical impedance of headphones is 32Ω .

Figure 5 also shows the suggested headphone jack electrical connections. The jack is designed to mate with a four wire (or three wire)plug. The plug's tip and ring should each carry one of the two stereo output signals, whereas the sleeve should carry the ground return. The headphone jack with one control pin contact is sufficient to drive the HP Sense pin when connecting headphones.

As outlined above driving the Speaker (BTL) and Headphone (SE) loads simultaneously using LY8661 is simple and easy. However this configuration will only work if the HP Logic pin is used to control the BTL/SE operation and HP Sense pin is connected to GND(Figure 6).

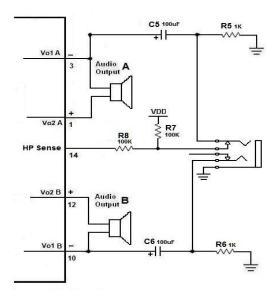


FIGURE 5. With Headphone Circuit (QFN Type)

www.DataSheet4U.com

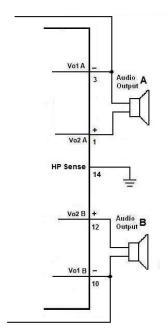


FIGURE 6. Without Headphone Circuit (QFN Type)



Rev. 1.8

Dual 2.0W/CH Stereo Audio Amplifier include Headphone Function

Bypass Capacitor Value Selection

Besides minimizing the input capacitor size, careful consideration should be paid to value of C4, the capacitor connected to the BYPASS pin. Since C4 determines how fast the LY8661 settles to quiescent operation, its value is critical when minimizing turn-on pops. The slower the LY8661's outputs ramp to their quiescent DC voltage (nominally 1/2 VDD), the smaller the turn-on pop. Choosing C4 equal to 1.0 μ F along with a small value of C2,C3 (in the range of 0.1 μ F to 0.39 μ F), produces a click-less and pop-less shutdown function. As discussed above, choosing C1 no larger than necessary for the desired bandwith helps minimize clicks and pops. Connecting a 1 μ F capacitor, C4, between the BYPASS pin and ground improves the internal bias voltage's stability and improves the amplifier's PSRR.

OPTIMIZING CLICK AND POP REDUCTION PERFORMANCE

The LY8661 contains circuitry that minimizes turn-on and shutdown transients or "clicks and pop". For this discussion, turn-on refers to either applying the power supply voltage or when the shutdown mode is deactivated. When the part is turned on, an internal current source changes the voltage of the BYPASS pin in a controlled, linear manner. Ideally, the input and outputs track the voltage applied to the BYPASS pin. The gain of the internal amplifiers remains unity until the voltage on the bypass pin reaches 1/2 VDD. As soon as the voltage on the bypass pin is stable, the device becomes fully operational. Although the BYPASS pin current cannot be modified, changing the size of C4 alters the device's turn-on time and the magnitude of "clicks and pops". Increasing the value of C4 reduces the magnitude of turn-on pops. However, this presents a tradeoff: as the size of C4 increases, the turn-on time increases. There is a linear relationship between the size of C4 and the turn-on time. Here are some typical turn-on times for various values of C4: In order eliminate "clicks and pops", all capacitors must be discharged before turn-on. Rapidly switching VDD on and off may not allow the capacitors to fully discharge, which may cause "clicks and pops".

TABLE 2. C4 and Ton Truth Table

C4	TON (Typ.) at 5.0V	
1.0uF	172 ms	
0.47uF	76 ms	
0.33uF	60 ms	
0.22uF	50 ms	
0.1uF	36 ms	

www.DataSheet4U.com

Lyontek Inc. reserves the rights to change the specifications and products without notice.

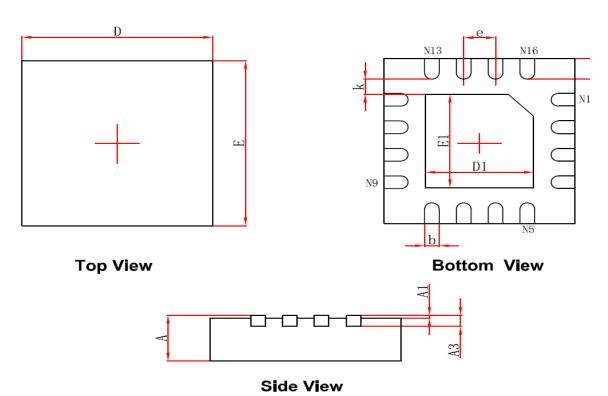
5F, No. 2, Industry E . Rd. IX, Science-Based Industrial Park, Hsinchu 300, Taiwan

Rev. 1.8

Dual 2.0W/CH Stereo Audio Amplifier include Headphone Function

PACKAGE OUTLINE DIMENSION

16-Pin QFN 3X3 Package Outline Dimension



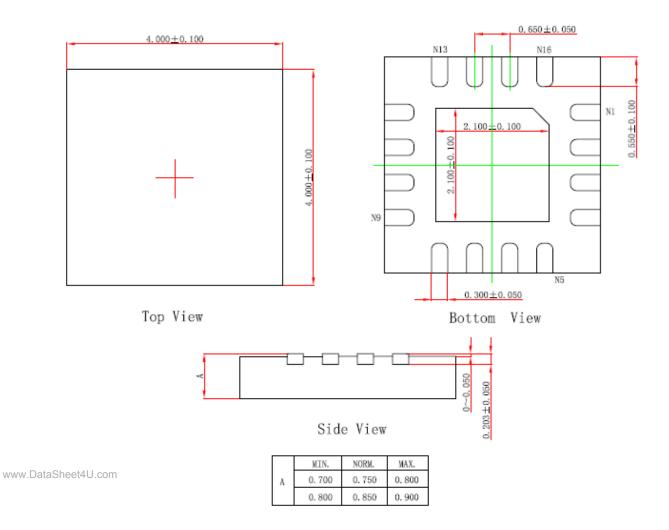
www.DataSheet4U.com

Symbol	Dimensions In Millimeters			
Symbol	Min.	Max.		
Α	0.700/0.800	0.800/0.900		
A1	0.000	0.050		
A3	0.203REF.			
D	2.900	3.100		
E	2.900	3.100		
D1	1.600	1.800		
E1	1.600	1.800		
k	0.200MIN.			
b	0.180	0.300		
е	0.500TYP.			
L	0.300 0.500			

Rev. 1.8

Dual 2.0W/CH Stereo Audio Amplifier include Headphone Function

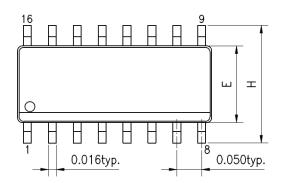
16-Pin QFN 4X4 Package Outline Dimension

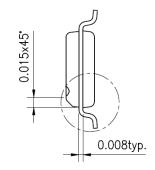


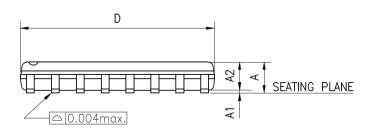
Rev. 1.8

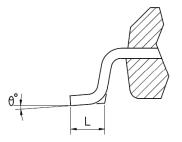
Dual 2.0W/CH Stereo Audio Amplifier include Headphone Function

16 Pin SOP Package Outline Dimension









www.DataSheet4U.com

	STANDARD				
SYMBOLS	MIN.	MAX.			
А	0.053	0.069			
A1	0.004	0.010			
A2	0.049	0.065			
D	0.386	0.394			
E	0.150	0.157			
Н	0.228	0.244			
L	0.016	0.050			
θ°	0	8			

UNIT : INCH